

STF20NK50Z, STP20NK50Z

N-channel 500 V, 0.23 Ω 17 A SuperMESH™ Power MOSFET Zener-protected in TO-220FP and TO-220 packages

Features

| Order codes | V _{DSS} | R _{DS(on)} max | I _D | P _{TOT} |
|-------------|------------------|----------------------------|----------------|------------------|
| STF20NK50Z | 500 V | < 0.27 Ω | 17 A | 40 W |
| STP20NK50Z | 500 V | < 0.27 Ω | 17 A | 190 W |

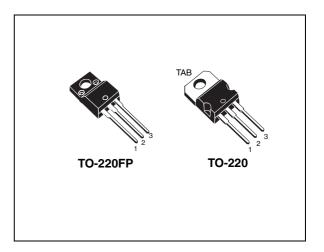
- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very low intrinsic capacitance

Applications

Switching applications

Description

These devices are N-channel Zener-protected Power MOSFETs developed using STMicroelectronics' SuperMESH[™] technology, achieved through optimization of ST's well established strip-based PowerMESH[™] layout. In addition to a significant reduction in onresistance, this device is designed to ensure a high level of dv/dt capability for the most demanding applications.



Datasheet — production data

Figure 1. Internal schematic diagram

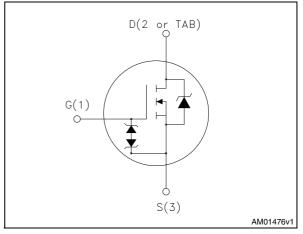


Table 1. Device summary

| Order codes | Marking | Package | Packaging |
|-------------|----------|----------|-----------|
| STF20NK50Z | F20NK50Z | TO-220FP | Tube |
| STP20NK50Z | P20NK50Z | TO-220 | lube |

Doc ID 023060 Rev 1

1/15

This is information on a product in full production.

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1 Electrical ratings

Table 2.Absolute maximum ratings

| Symbol | Parameter | Value | 9 | Unit |
|--------------------------------|--|--------------------------------------|----------------------|------|
| Symbol | Parameter | TO-220 | TO-220FP | Unit |
| V _{DS} | Drain-source voltage | 500 | | V |
| V _{GS} | Gate-source voltage | ± 30 | | V |
| I _D | Drain current (continuous) at $T_C = 25 \ ^{\circ}C$ | 17 | 17 ⁽¹⁾ | А |
| Ι _D | Drain current (continuous) at $T_C = 100 \ ^{\circ}C$ | 10.71 | 10.71 ⁽¹⁾ | А |
| I _{DM} ⁽²⁾ | Drain current (pulsed) | 68 | 68 | А |
| P _{TOT} | Total dissipation at $T_{C} = 25 \ ^{\circ}C$ | 190 | 40 | W |
| | Derating factor | 1.52 | 0.32 | W/°C |
| V _{ISO} | Insulation withstand voltage (RMS) from all three leads to external heat sink $(t = 1 \text{ s}; T_C = 25 \text{ °C})$ | ree leads to external heat sink 2500 | | V |
| ESD | Gate-source human body model (R=1.5 kΩ C=100 pF) | 6 | | kV |
| dv/dt ⁽³⁾ | Peak diode recovery voltage slope | 4.5 | | V/ns |
| T _{stg} | Storage temperature | -55 to 150 | | °C |
| Т _ј | Max operating junction temperature | 150 | | °C |

1. Limited by maximum junction temperature.

2. Pulse width limited by safe operating area.

3. I_{SD} $\ \le 17$ A, di/dt $\ \le \ 200$ A/µs, V_{DD} $\ \le \ V_{(BR)DSS}, \, T_{j} \ \le T_{JMAX.}$

Table 3.Thermal data

| Symbol | Parameter | Value | Unit | |
|-----------------------|---|--------|----------|------|
| Symbol | Falameter | TO-220 | TO-220FP | Onit |
| R _{thj-case} | Thermal resistance junction-case max | 0.66 | 3.1 | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient max | 62.5 | 62.5 | °C/W |

Table 4. Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|--|-------|------|
| I _{AR} | Avalanche current, repetitive or not- repetitive (pulse width limited by Tj max) | 17 | A |
| E _{AS} | Single pulse avalanche energy (starting T _J =25 °C, I _D =I _{AR} , V _{DD} =50 V) | 850 | mJ |



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|----------------------|--|---|------|------|---------|----------|
| V _{(BR)DSS} | Drain-source breakdown voltage | I _D =1 mA, V _{GS} = 0 | 500 | | | V |
| I _{DSS} | Zero gate voltage drain current (V _{GS} = 0) | V _{DS} = 500 V V _{DS} = 500 V, T _C = 125 °C | | | 1 50 | μΑ μΑ |
| I _{GSS} | Gate-body leakage current (V _{DS} = 0) | V _{GS} = ± 20 V | | | ± 10 | μA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 100 \ \mu A$ | 3 | 3.75 | 4.5 | V |
| R _{DS(on)} | Static drain-source on-resistance | V _{GS} = 10 V, I _D = 8.5 A | | 0.23 | 0.27 | Ω |

Table 5. On/off states

Table 6. Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---|---|--|------|----------------------|------|----------------------|
| C _{iss} C _{oss} C _{rss} | Input capacitance Output capacitance Reverse transfer capacitance | V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 | - | 2600 328 72 | | pF pF pF |
| C _{oss eq.} ⁽¹⁾ | Equivalent output capacitance | $V_{DS} = 0, V_{DS} = 0 \text{ to } 640 \text{ V}$ | - | 187 | | pF |
| t _{d(on)} t _r t _{d(off)} t _f | Turn-on delay time Rise time Turn-off delay time Fall time | $V_{DD} = 250 \text{ V}, I_D = 8.5 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see <i>Figure 16</i>) | - | 28 20 70 15 | | ns ns ns ns |
| Q _g Q _{gs} Q _{gd} | Total gate charge Gate-source charge Gate-drain charge | $V_{DD} = 400 \text{ V}, I_D = 17 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see <i>Figure 17</i>) | - | 85 15.5 42 | 119 | nC nC nC |

1. C_{oss eq.} is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}.



| Table 7. | Source drain diode | | | | | |
|--|--|---|------|-------------------|----------|---------------|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| I _{SD} I _{SDM} ⁽¹⁾ | Source-drain current Source-drain current (pulsed) | | - | | 17 68 | A A |
| V _{SD} ⁽²⁾ | Forward on voltage | $I_{SD} = 17 \text{ A}, V_{GS} = 0$ | - | | 1.6 | V |
| t _{rr} Q _{rr} I _{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_{SD} = 17 \text{ A},$ di/dt = 100 A/µs $V_R = 100 \text{ V}$ (see <i>Figure 18</i>) | - | 355 3.90 22 | | ns μC Α |
| t _{rr} Q _{rr} I _{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | I _{SD} = 17 A, di/dt = 100 A/μs V _R = 100 V, Tj = 150 °C (see <i>Figure 18</i>) | - | 440 5.72 26 | | ns μC Α |

Table 7.Source drain diode

1. Pulsed: pulse duration=300µs, duty cycle 1.5%

2. Pulse width limited by safe operating area

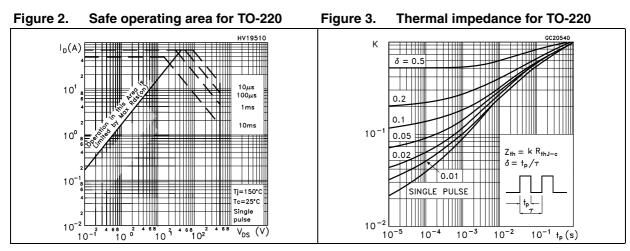
Table 8.Gate-source Zener diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|-------------------|-------------------------------|------------------------|------|------|------|------|
| BV _{GSO} | Gate-source breakdown voltage | lgs=± 1mA (open drain) | 30 | - | | V |

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.



Electrical characteristics (curves) 2.1





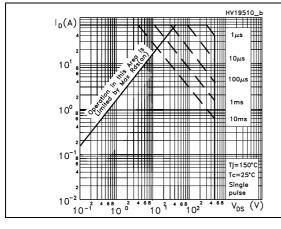


Figure 6. **Output characteristics**

6

12

18

Vcs=10V

lo(A)

40

30

20

10

0

HV12880

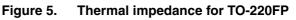
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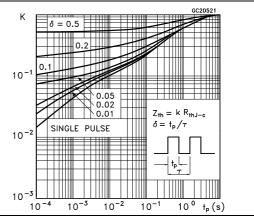
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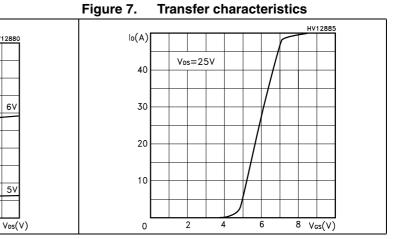
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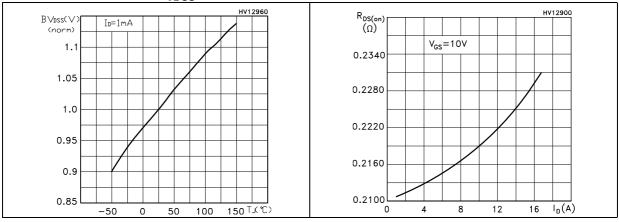
87 77















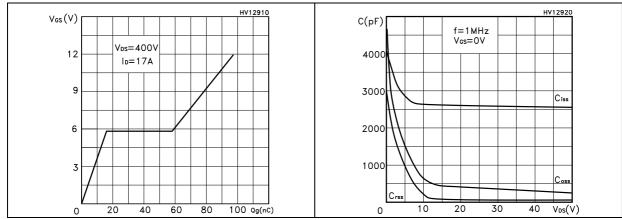


Figure 12. Normalized gate threshold voltage Figure 13. vs temperature

13. Normalized on-resistance vs temperature

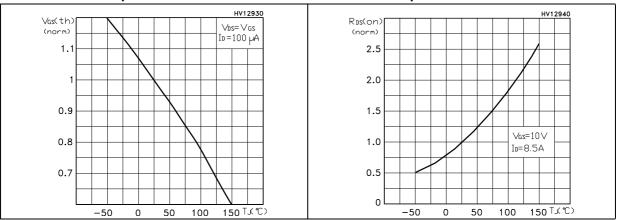
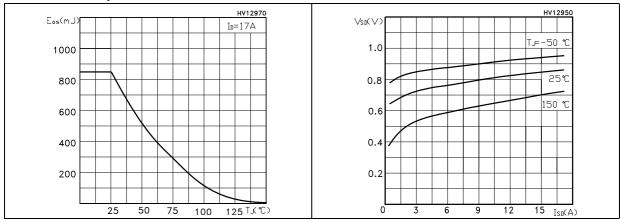
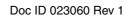




Figure 14. Maximum avalanche energy vs temperature

Figure 15. Source-drain diode forward characteristic

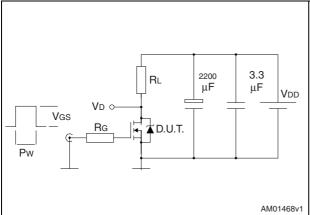






3 Test circuits

Figure 16. Switching times test circuit for resistive load



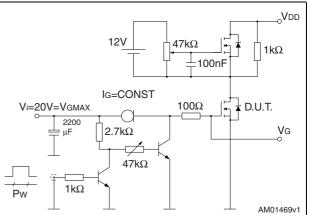
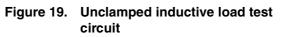
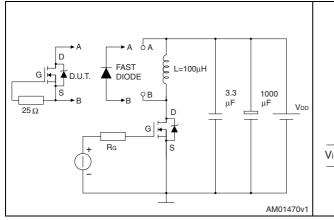


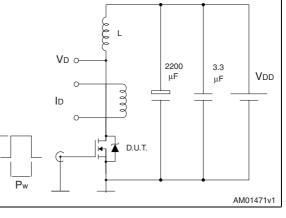
Figure 17. Gate charge test circuit

Figure 18. Test circuit for inductive load switching and diode recovery times

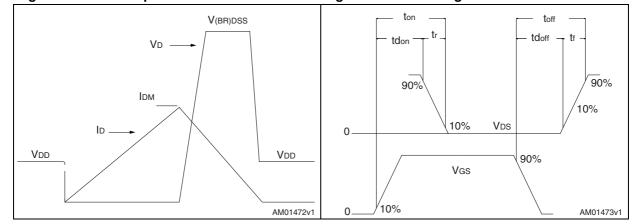














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4 Package mechanical data

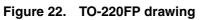
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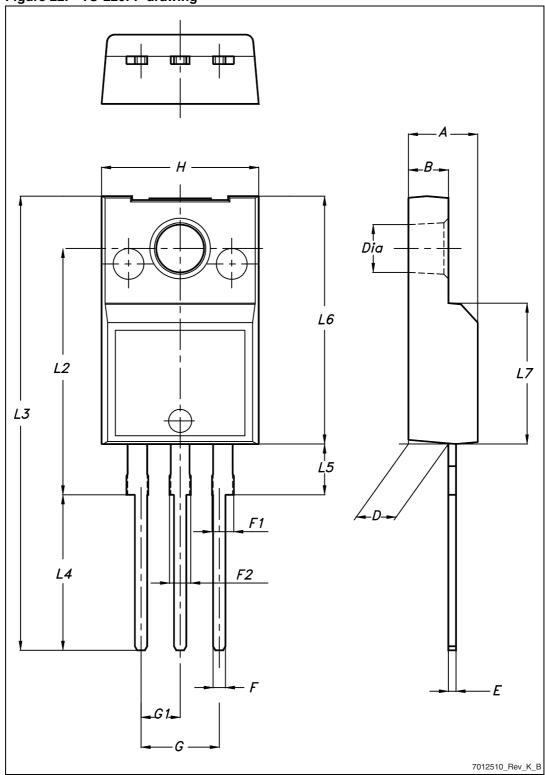
| Dim | | mm | |
|------|------|------|------|
| Dim. | Min. | Тур. | Max. |
| А | 4.4 | | 4.6 |
| В | 2.5 | | 2.7 |
| D | 2.5 | | 2.75 |
| Е | 0.45 | | 0.7 |
| F | 0.75 | | 1 |
| F1 | 1.15 | | 1.70 |
| F2 | 1.15 | | 1.70 |
| G | 4.95 | | 5.2 |
| G1 | 2.4 | | 2.7 |
| Н | 10 | | 10.4 |
| L2 | | 16 | |
| L3 | 28.6 | | 30.6 |
| L4 | 9.8 | | 10.6 |
| L5 | 2.9 | | 3.6 |
| L6 | 15.9 | | 16.4 |
| L7 | 9 | | 9.3 |
| Dia | 3 | | 3.2 |

Table 9. TO-220FP mechanical data



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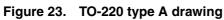


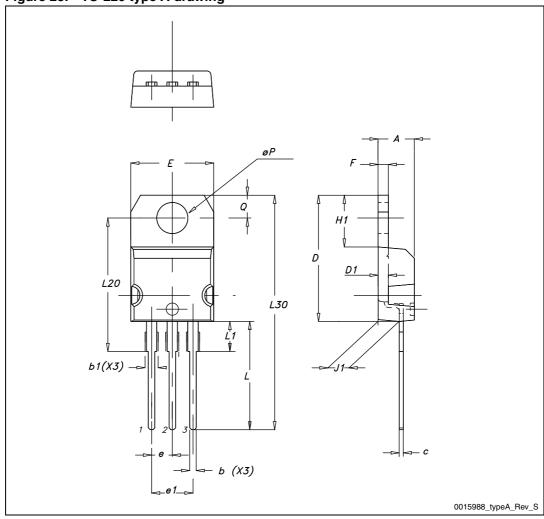


| Dim | | mm | |
|--------|-------|-------|-------|
| Dim. — | Min. | Тур. | Max. |
| А | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| С | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10 | | 10.40 |
| е | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| ØР | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Table 10. TO-220 type A mechanical data









5 Revision history

Table 11.Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 05-Apr-2012 | 1 | First release. |



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